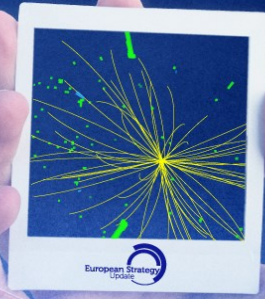


L'INFN e la  
Strategia Europea  
per la  
Fisica delle Particelle



Work supported by INFN CSN5 experiment SAMARA and INFN CSNI experiments SRF and RD\_FCC



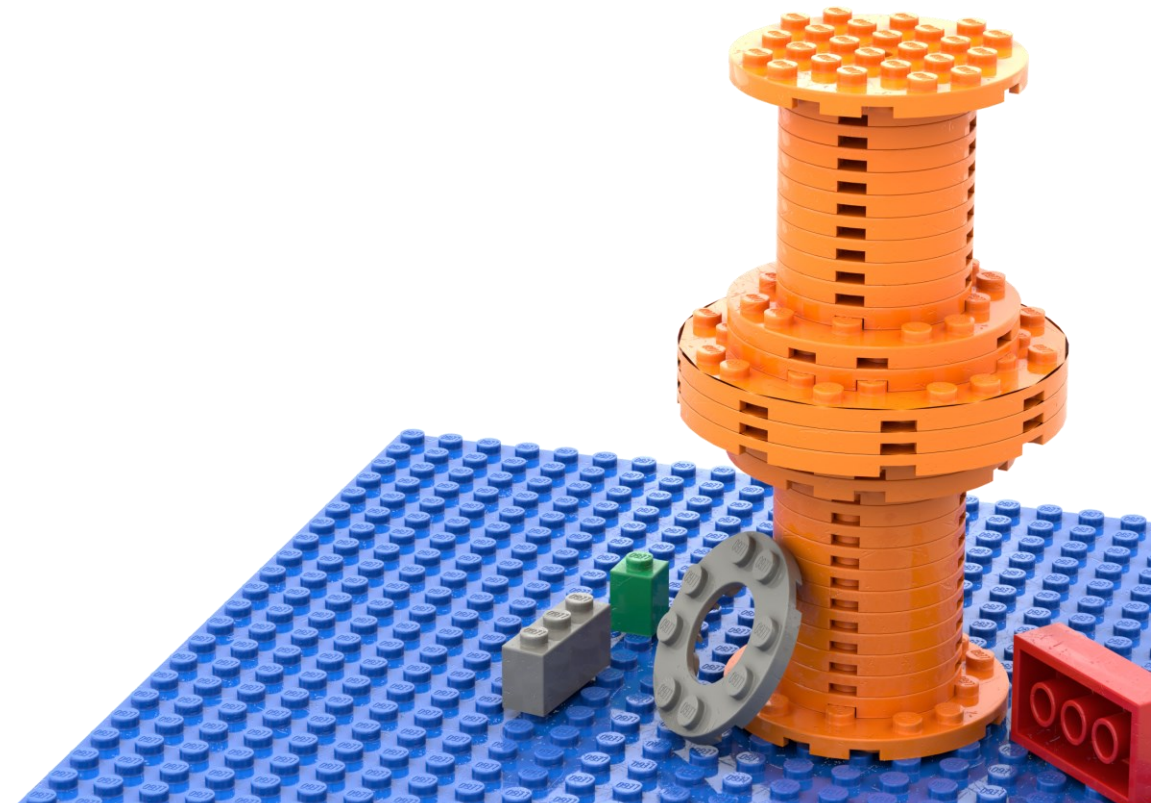
This project has received funding from the European Union's Horizon-INFRA-2023-TECH-01 under GA No 101131435 – ISAS and from the European Union's Horizon 2020 Research and Innovation programme under GA No 101004730 – I.FAST

**Roma 6-7 Maggio 2024**  
Centro Congresso Frentani

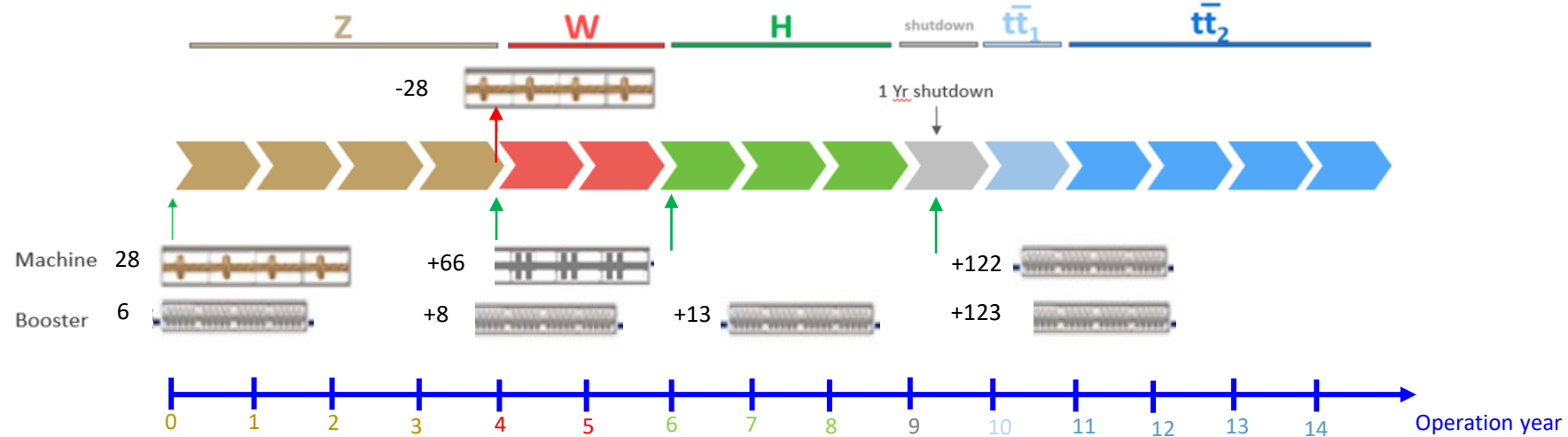


Cristian Pira

# Development of Thin Film SRF relevant for FCC



# SRF System Baseline for FCC



**In total: 366 CM, 1'464 cavities (4 cavities/CM, present assumption):**

- ▶ 400 MHz single-cell (Nb/Cu): 28 CM, 112 cavities → 4.5 K (to be removed after Z)
- ▶ 400 MHz two-cell (Nb/Cu): 66 CM, 264 cavities → 4.5 K
- ▶ 800 MHz five-cell (bulk Nb): 272 CM, 1'088 cavities → 2 K

**Collider** (ttbar2): 188 CM (264 cavities 400 MHz, 488 cavities 800 MHz)

**Booster** (ttbar2): 150 CM (600 cavities 800 MHz)

**Performance of thin film 400 MHz are one of the main challenges of FCC SRF System**

SRF System Baseline from Vittorio Parma, FCC week 2023

# 400 MHz requirements

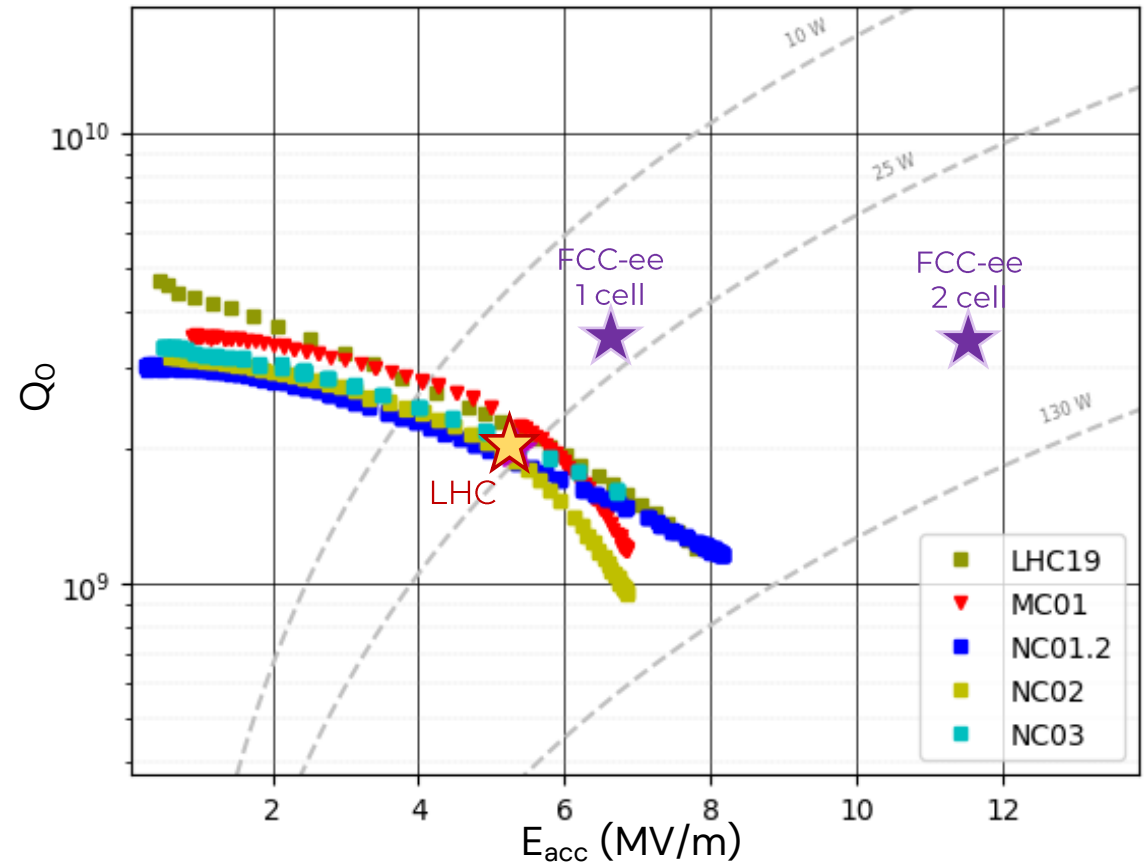


**FCC-ee** requires higher cavities performances than LHC

*Nb on Cu "baseline", Solid scheme with good margin for reliable operation Clear R&D paths identified (seamless copper cavities, HiPIMS coating, High Q0 bulk Nb cavities)*

*Franck Peauger, FCC week 2023*

LHC cavities Q vs  $E_{acc}$  @4.5 K

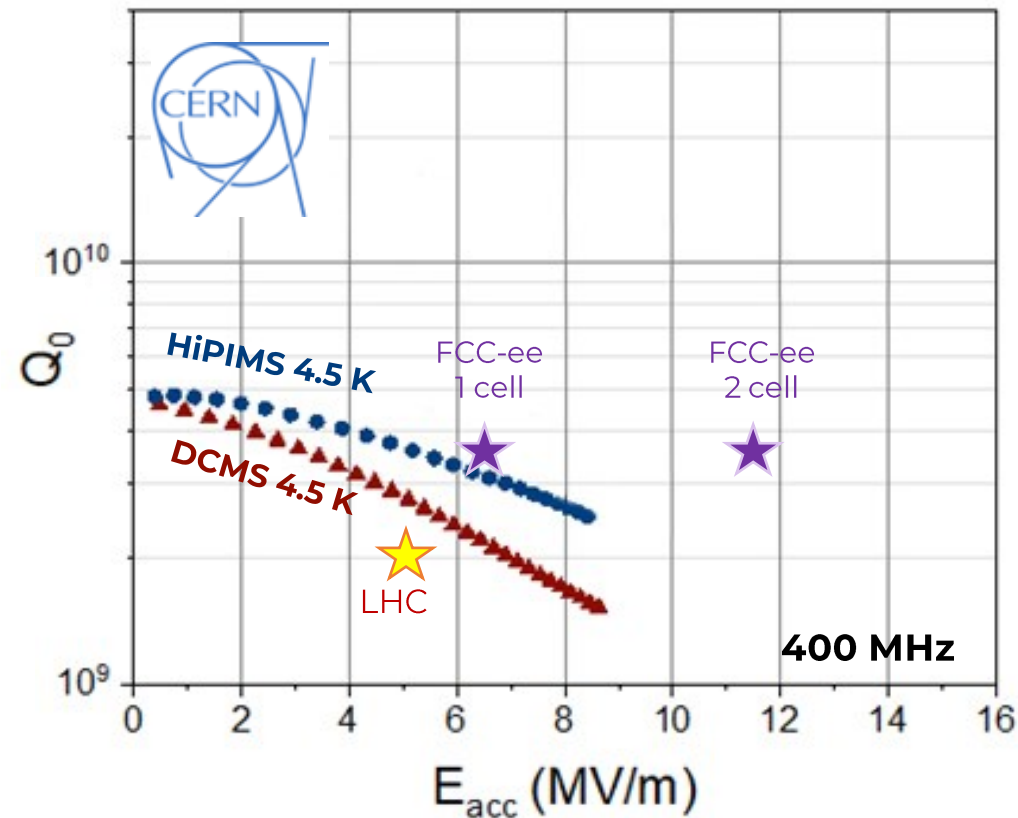
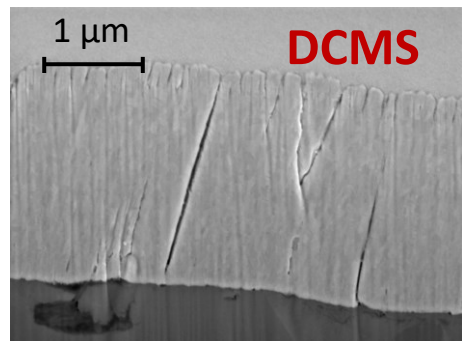
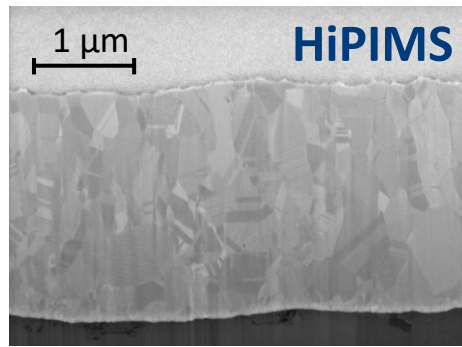


*Graph from Carlota Pereira Carlos, FCC week 2023*

# SRF R&D @CERN for FCC

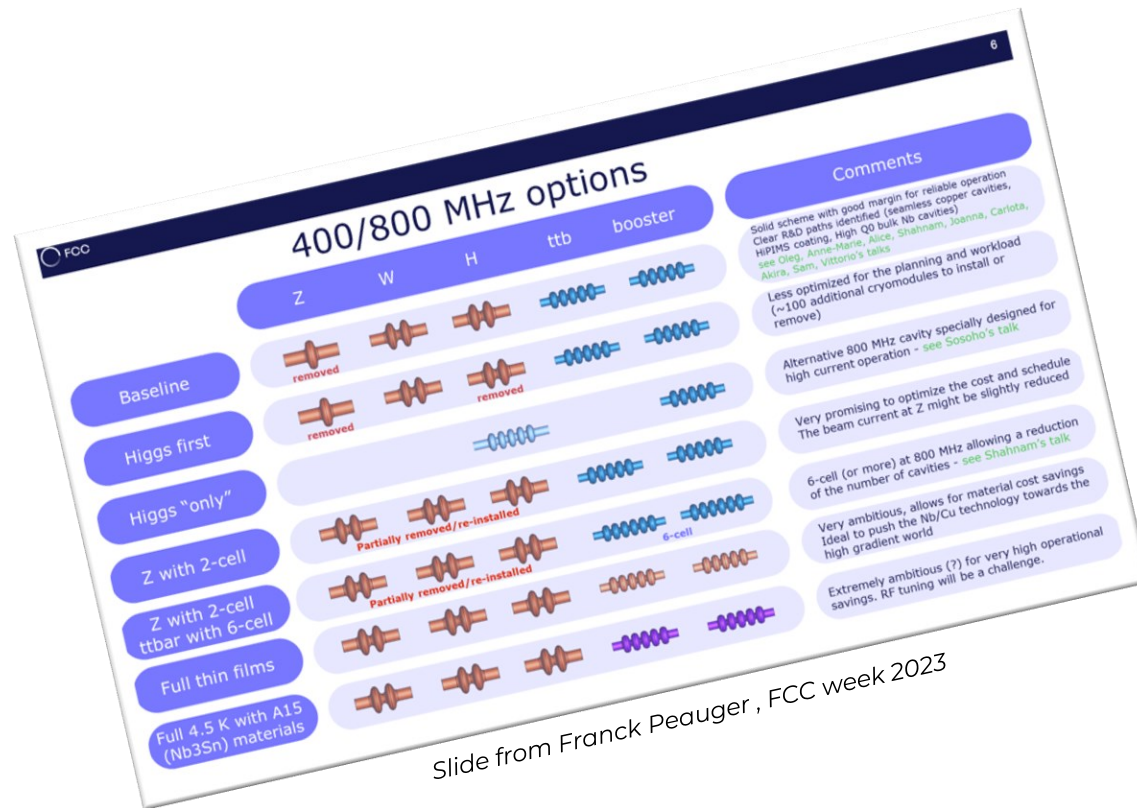
HiPIMS technology densifies the Nb coating and increases RF performances compared to DCMS

Carlota Pereira Carlos, FCC week 2023 (elaborated)



R&D @CERN also on cavity forming (hydroforming), polishing (EP), Cu oxide layer,  $\text{Nb}_3\text{Sn}$  by HiPIMS

# Other Option for FCC SRF System



**Full 4.5 K with A15 Materials → Nb<sub>3</sub>Sn**

*Extremely ambitious for very high operational savings*

# INFN LNL SRF R&D focused on $Nb_3Sn$ since 2021



The development of  $Nb_3Sn$  on Cu for SRF accelerating cavities is part of **European Strategy** for Particle Physics Accelerator - **R&D Roadmap**

INFN R&D started in a CSN5 experiment



INFN LNL has a **leadership role** in the two main **European Projects** on Thin Film SRF R&D:



A **dedicated Project** on R&D of interest of FCC has been **financed by INFN board**:

**SRF cavities R&D for FCC-ee**

INFN Accelerators European Strategy Program

**RD\_FCC**

INFN CSN1 Experiment

## International Partners:

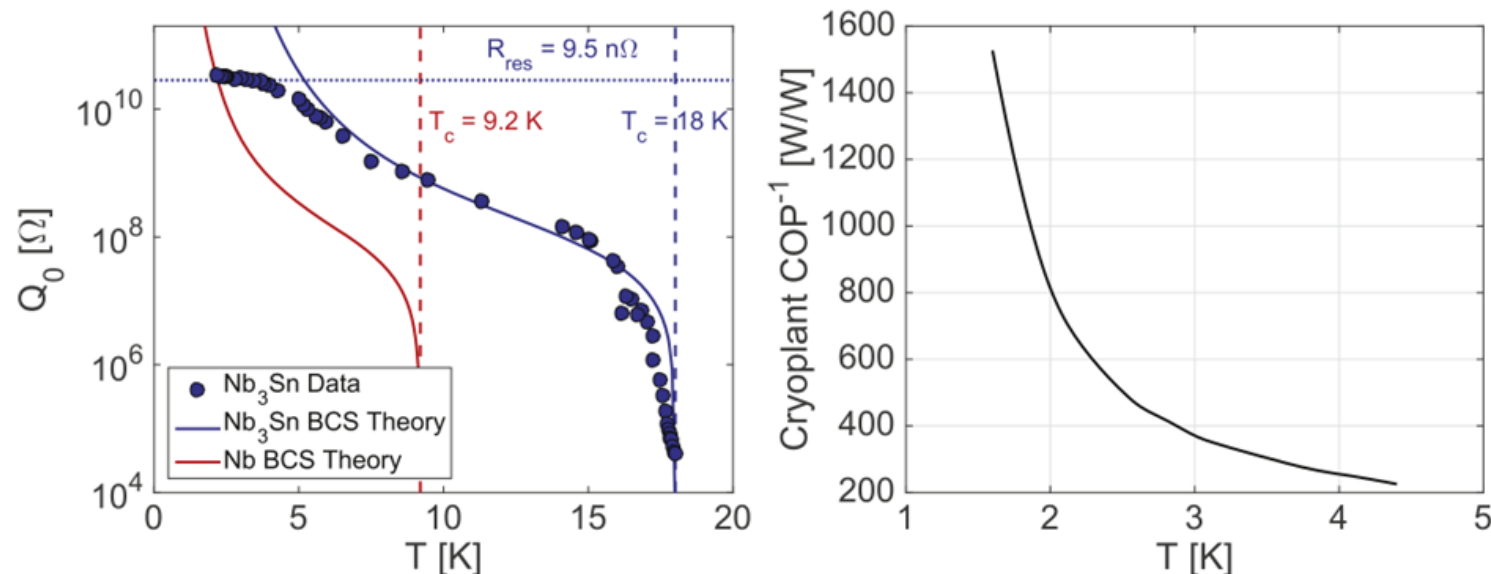


# Nb<sub>3</sub>Sn motivation

**Energy saving** is mandatory for **FCC-ee** and the **next generation accelerators**..

...**cryogenics** is one of the **larger energy cost** in modern SRF accelerators

➔ Move from **bulk Nb @2K** to **Nb<sub>3</sub>Sn @4.5 K**  
reduces cryogenic power by a factor of 3



Supercond. Sci. Technol. 30 (2017) 033004

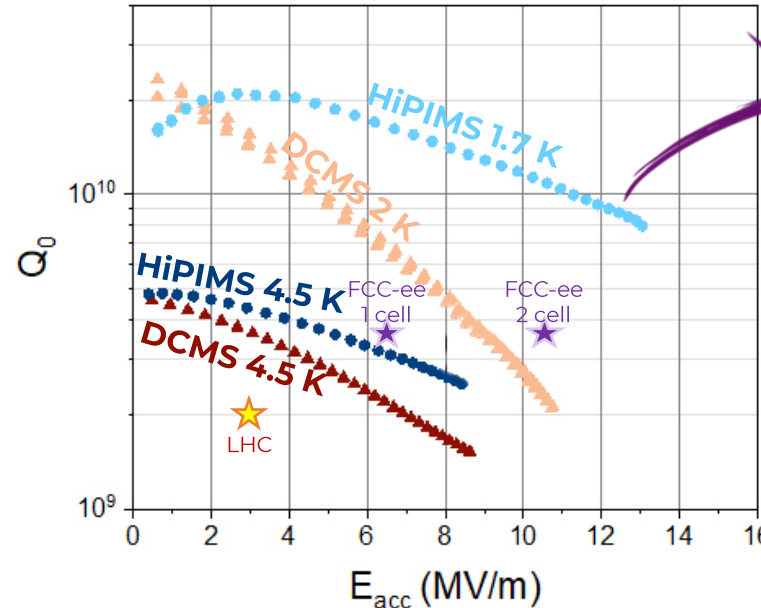
# Nb<sub>3</sub>Sn motivation

**Energy saving** is mandatory for **FCC-ee** and the **next generation accelerators**..

...**cryogenics** is one of the **larger energy cost** in modern SRF accelerators

Move from **thin film Nb @4.5 K** to **Nb<sub>3</sub>Sn @4.5 K**

Reduce  $T_{op}/T_c \rightarrow$  Suppress  $R_{BCS} \rightarrow$  Increase  $Q$



Expected Performances for Nb<sub>3</sub>Sn

Carlota Pereira Carlos, FCC week 2023 (elaborated)



# Nb<sub>3</sub>Sn on Cu: Multiple challenges

- ▶ A15 are Brittle materials
- ▶ Complicated Phase Diagram
- ▶ Low melting point substrate
- ▶ Interface diffusion
- ▶ Coating Parameters
- ▶ Substrate preparation
- ▶ Target Production/Magnetron Design
- ▶ Trapped Flux
- ▶ Tuning



# Nb<sub>3</sub>Sn on Cu: Multiple challenges

- ▶ Al5 are Brittle materials
- ▶ Complicated Phase Diagram
- ▶ Low melting point substrate
- ▶ **Interface diffusion**
- ▶ **Coating Parameters**
- ▶ **Substrate preparation**
- ▶ **Target Production/Magnetron Design**
- ▶ **Trapped Flux**
- ▶ **Tuning**



SRF cavities  
R&D for  
FCC-ee

INFN Accelerators European  
Strategy Program



# TRL evolution

First test in 2021



MAIN GOAL (2025):  
Produce a prototype of high performance 1.3 GHz thin film SRF elliptical cavity  
 $Q > 1 \cdot 10^{10}$  @ 4.5 K



**SRF cavities  
R&D for  
FCC-ee**

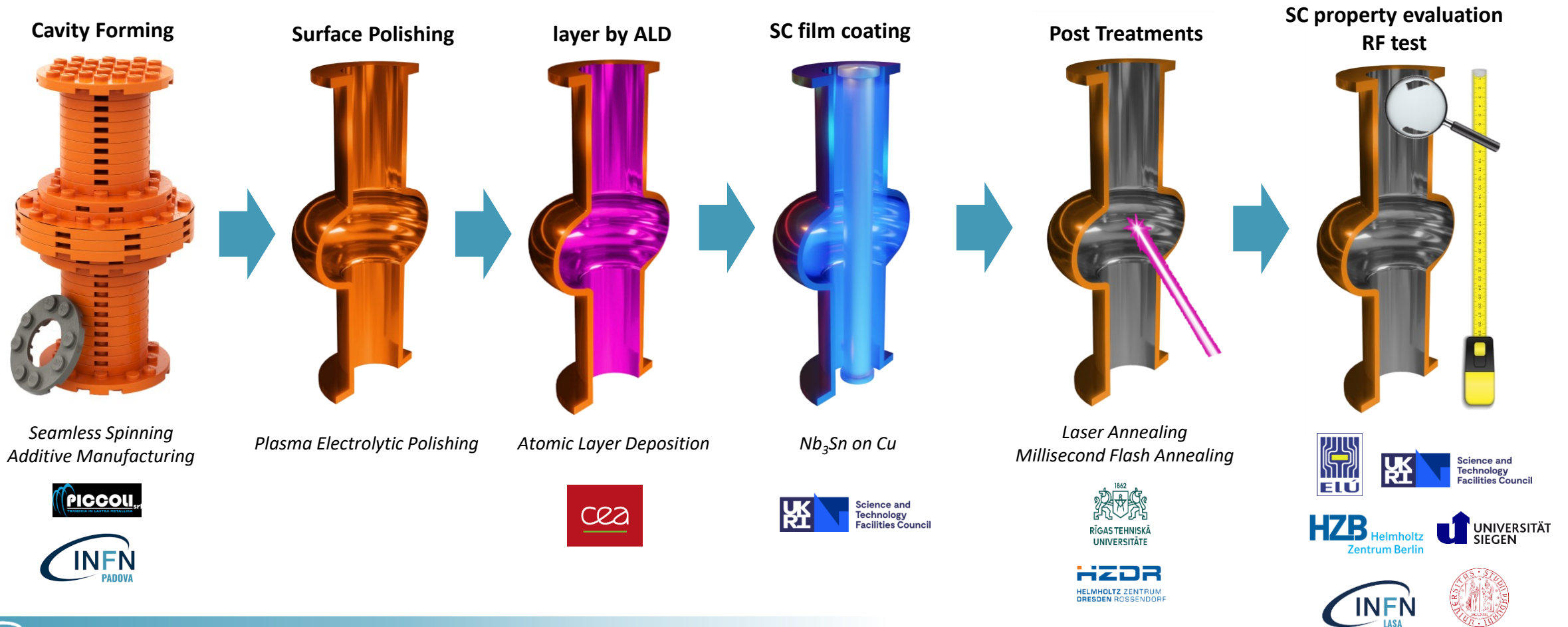
INFN Accelerators European Strategy Program

**A step forward in TRL**

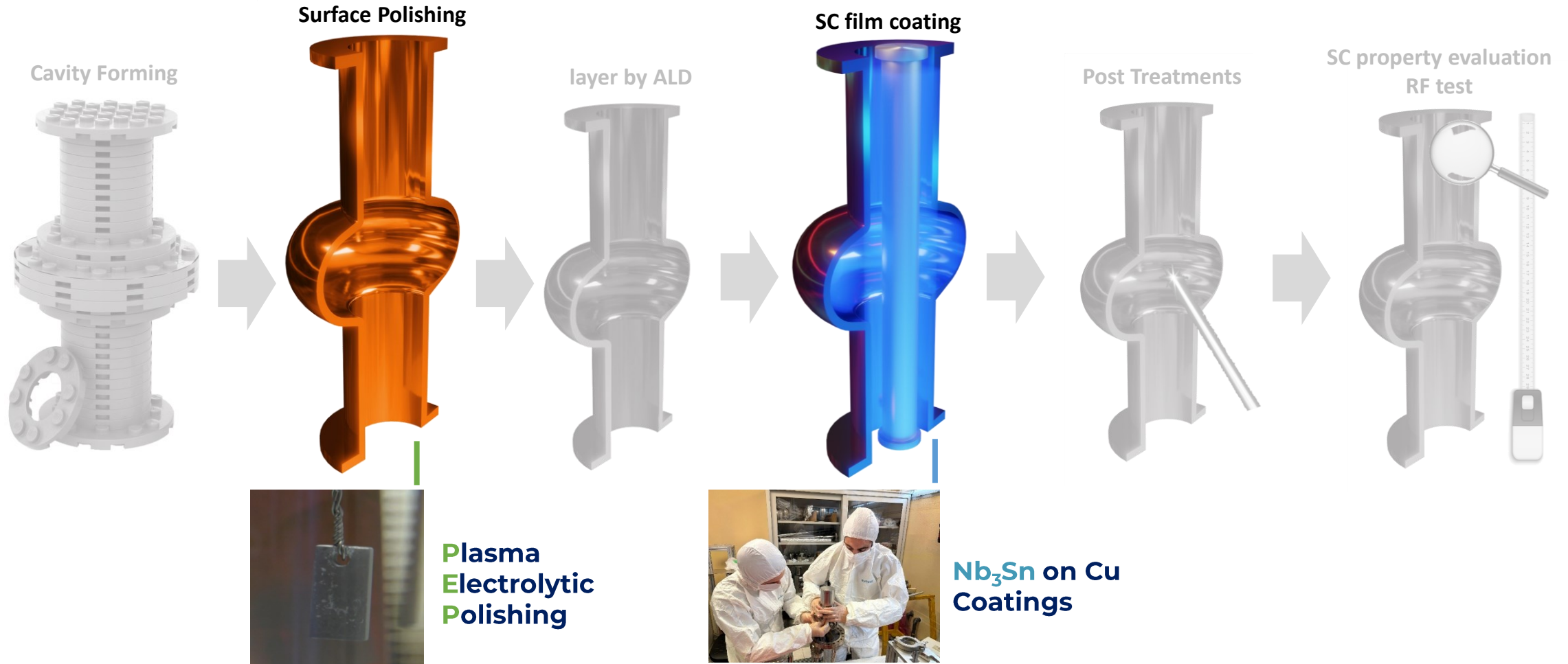
Focus on:

- minimizing **trapped flux**
- increasing coating mechanical strength (to allow **cavity tunability**)

# INFN LNL R&D activity covers all cavity production chain

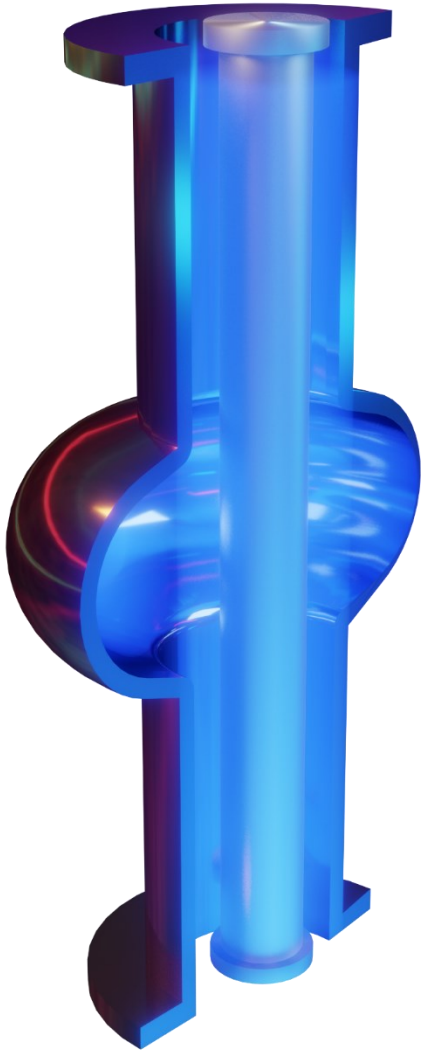


# In SRF project 2 technologies are developed in prospective of FCC



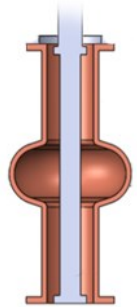
# SRF Project is supported by CERN

- ▶ **The project has been defined through several meetings with Walter Venturini (RF Group) and Guillaume Rosaz (Coating Group)**
- ▶ **CERN will support and participate to the project via SRF R&D program**
- ▶ **A INFN-CERN MOU is in preparation**



# $Nb_3Sn$ on Cu Coatings

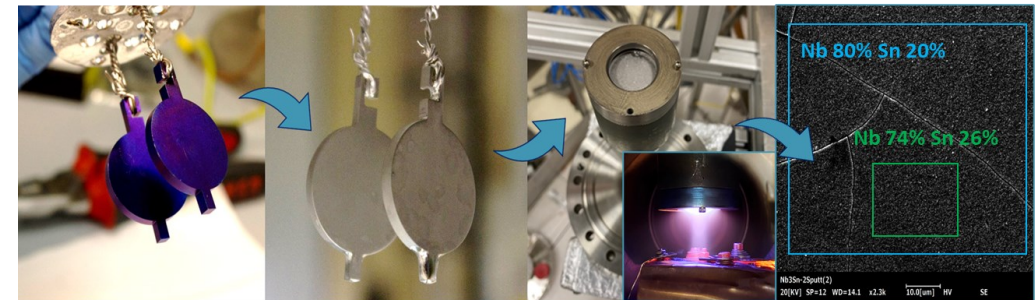
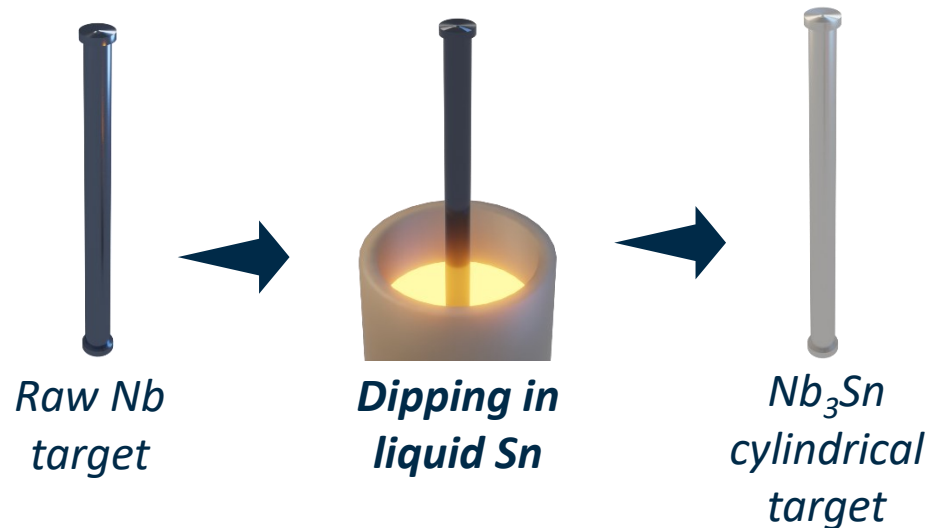
# Nb<sub>3</sub>Sn coatings: target production



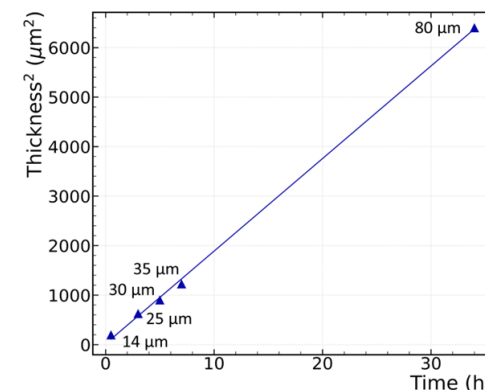
Single target configuration **easiest to scale** onto elliptical geometry

Nb<sub>3</sub>Sn cylindrical targets are not commercially available

**LNL Strategy for Nb<sub>3</sub>Sn cylindrical targets production for 6 GHz cavities**



Proof of concept



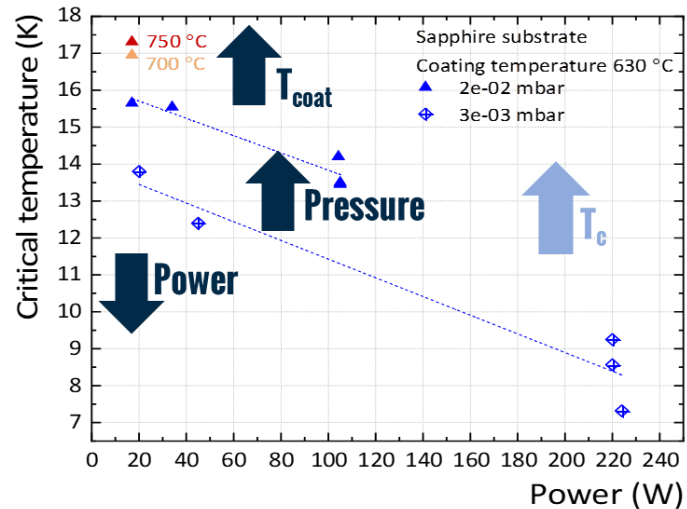
Nb<sub>3</sub>Sn **thickness** related to **dipping time**

Possible **tin content modulation**



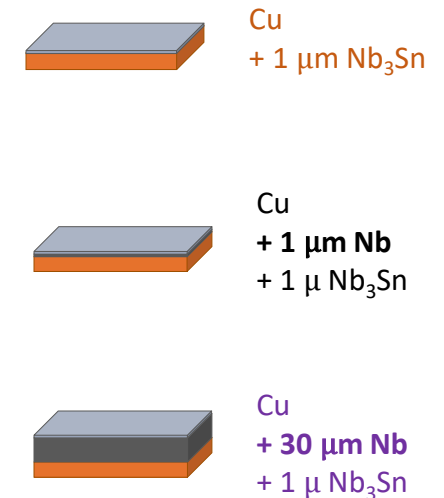
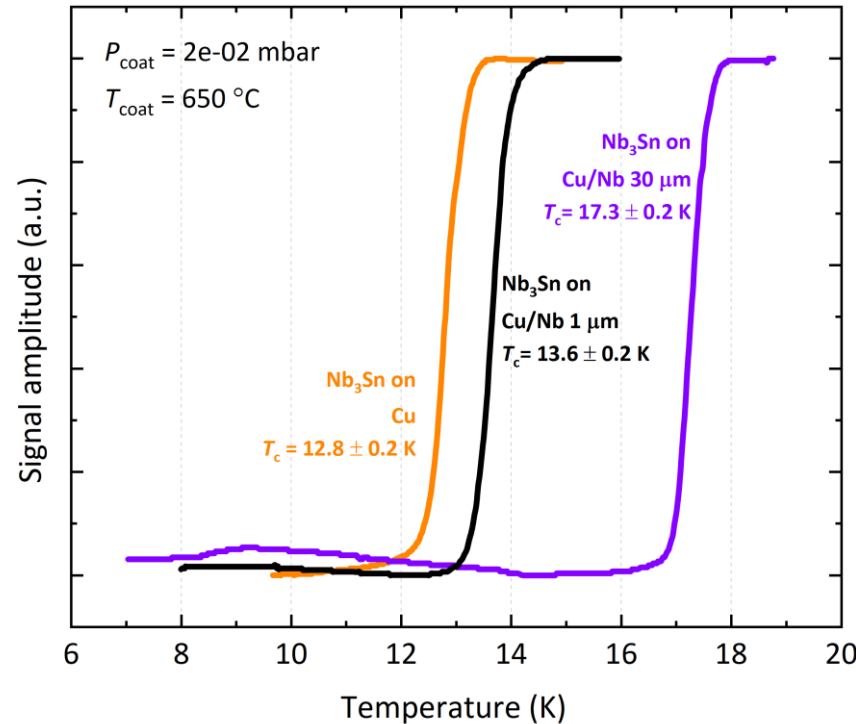
# Nb<sub>3</sub>Sn Coatings

## Long R&D phase on PVD Parameter Optimization



## Optimized Coating Recipe

- Coating Parameters:
  - Pressure =  $2 \cdot 10^{-2}$  mbar
  - Power = 16 W
  - T substrate  $\geq 600$  C
- **Nb Thick Barrier Layer > 30  $\mu$ m**



**A thick Nb buffer layer accommodates the Nb<sub>3</sub>Sn coating**

**Nb substrate can be used to validate Nb<sub>3</sub>Sn Coating Performances**

# First Nb<sub>3</sub>Sn RF Results

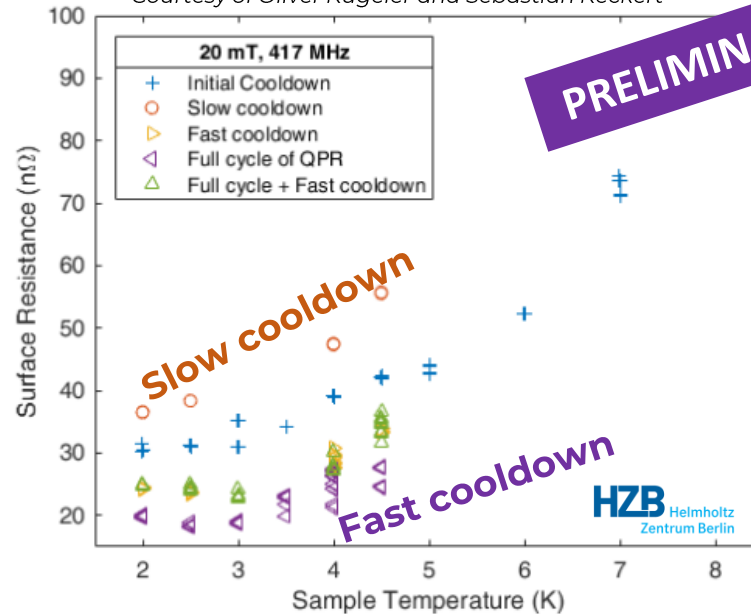
## (on a small Nb planar resonator)



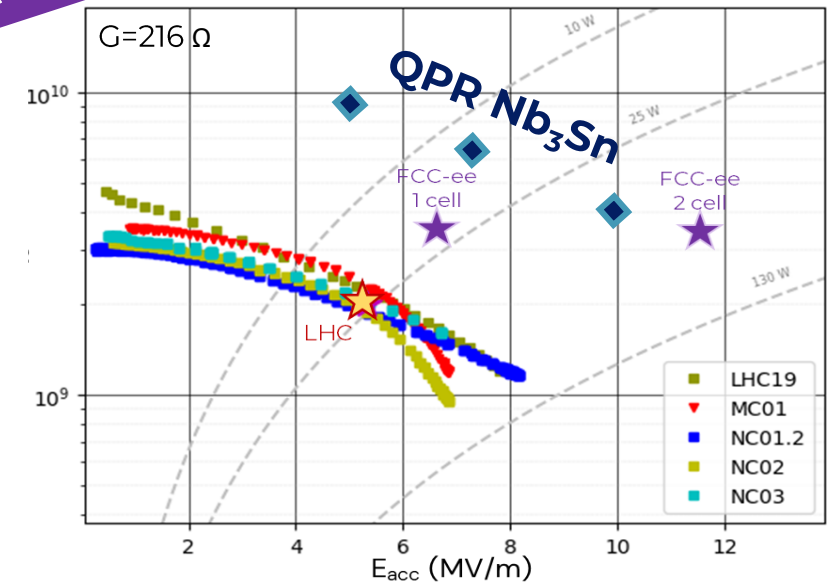
Rs of 23 nΩ @ 4.5 K, 20 mT  
 Quench >70 mT @ 4.5 K

- ▶ Nb<sub>3</sub>Sn coating suffer flux trapping
- ▶ Cooldown procedure influence Rs

Courtesy of Oliver Kugeler and Sebastian Keckert



LHC cavities Q vs E<sub>acc</sub> @4.5 K



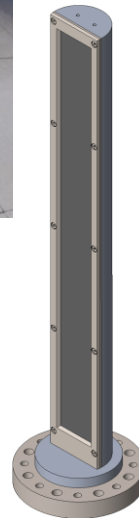
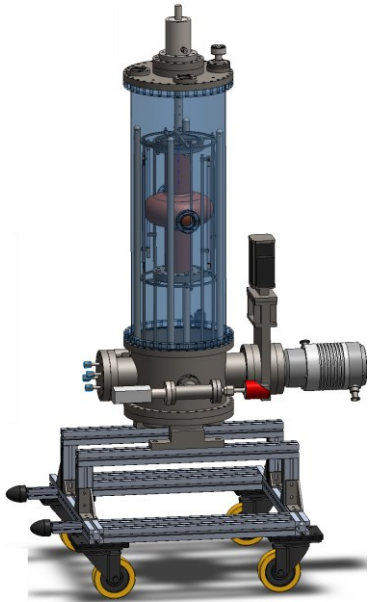
Equivalent to a Q of 9·10<sup>9</sup> @5 MV/m @4.5 K  
 Almost 1 order of magnitude better than LHC!!!  
 Room for improvement

# Nb<sub>3</sub>Sn Path to Final Prototype

Nb<sub>3</sub>Sn on bulk Nb to validate coating performances (2025)  
on 1.3 GHz Elliptical Cavities (2025)

Develop Nb thick barrier/accommodation layer on 1.3 GHz Elliptical Cavities (2025)  
(proof of concept on 6 GHz cavities already done)

Nb<sub>3</sub>Sn on Cu with thick Nb coating on 1.3 GHz Elliptical Cavities (2026-2028)

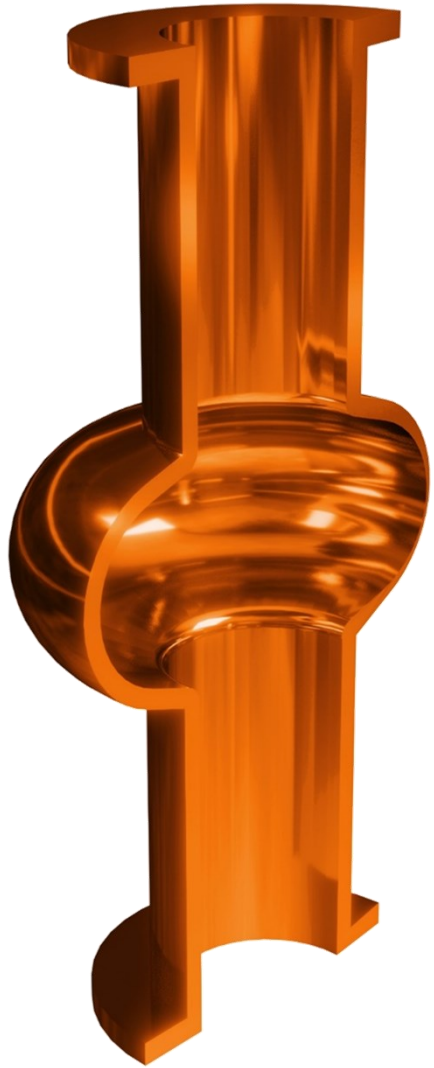


- ▶ 1.3 GHz Vacuum system ready
- ▶ Magnetron source commissioned

*In parallel:*

- ▶ Study on alternative buffer layer
- ▶ Study on flux trapping

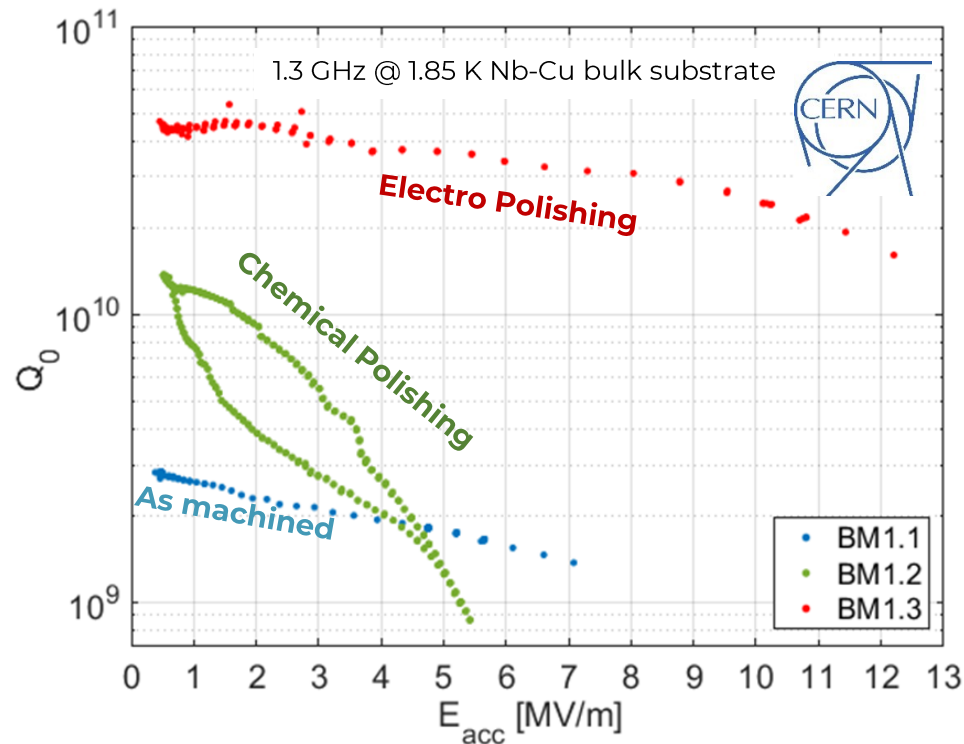




# Surface Polishing

## PEP

# Surface Polishing



L. Vega Cid, TTC meeting 2022 (elaborated)

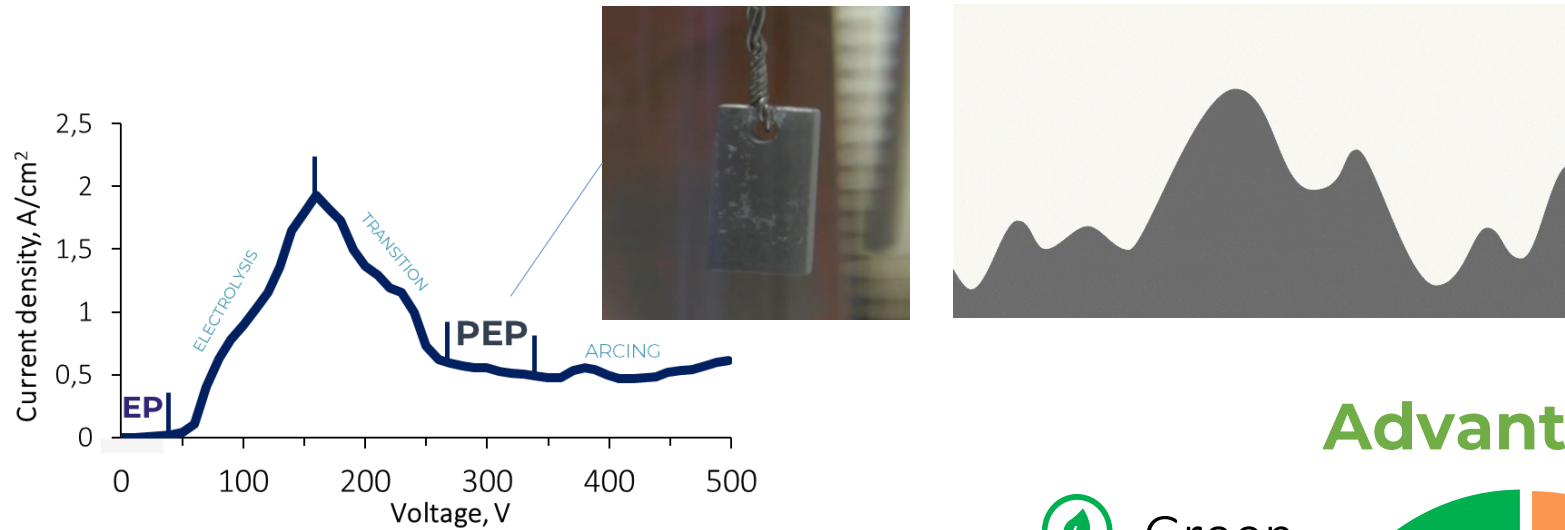
Cu substrate plays a fundamental role in SRF performances

Roughness and defects reduction by **surface treatments are mandatory** for a good and uniform SRF coating

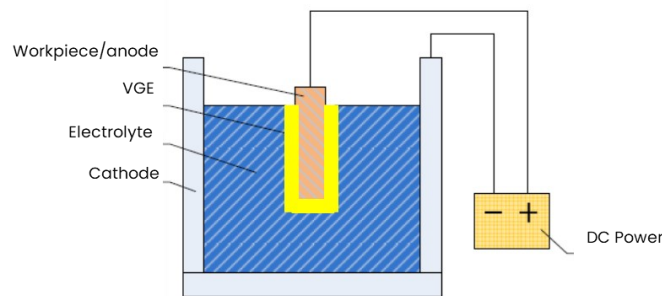
Cavity polishing requires **large amount of acids**. In particular **Nb** requires **HF** (extremely dangerous and poisoning process)



# Plasma Electrolytic Polishing PEP Mechanism



Same EP set-up  
Different regime



J. Wang et al., AMR, 2012

## Advantages



**Green**  
Diluted water solutions,  
environmentally friendly

**Fast**

The fastest  
non-destructive  
polishing

Equal thickness removal yield  
lowest roughness among  
competitors

**Efficiency**

**Plasma  
Electrolytic  
Polishing**

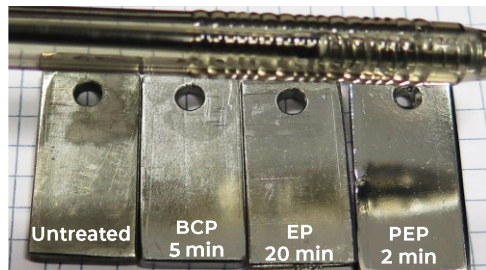
Less sensitive to the  
cathode shape!  
AM compatible

**Versatility**

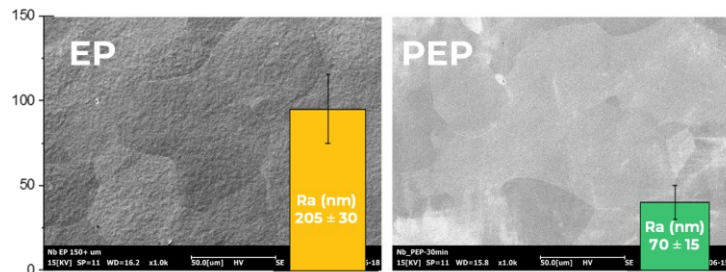
# Plasma Electrolytic Polishing **PEP** Results

1x Nb 3x Cu  
Solution Patents by INFN

## Planar samples



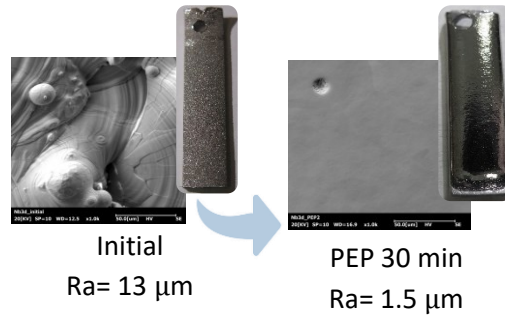
6.5  $\mu\text{m}$  removed



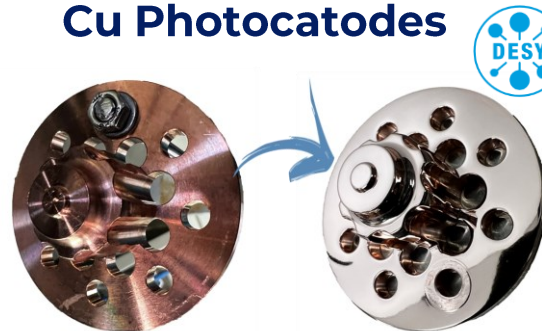
150  $\mu\text{m}$  removed in ~ 5 h

150  $\mu\text{m}$  removed in ~ 40 min

## Additive Manufacturing



## Cu Photocathodes



Ra ~ 8 nm!!!

## QPR Samples



Nb QPR polishing optimization on-going

Full Cu QPR ready for coating

HZB Helmholtz Zentrum Berlin

## 6 GHz Cu cavity



**No internal cathode!**

70  $\mu\text{m}$  removed in 10 minutes  
30 A (100  $\text{cm}^2 \rightarrow 1.3 \text{ GHz} \sim 300 \text{ A}$ )

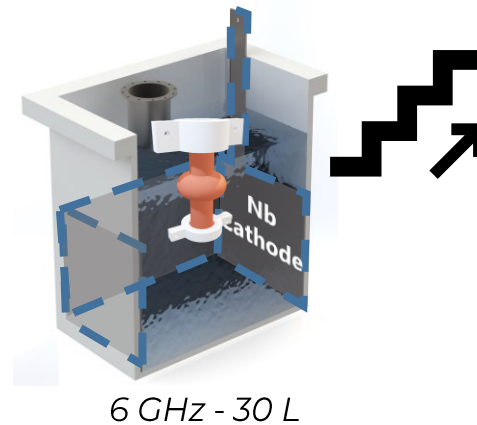
Courtesy of E. Chyhyrnyts

# PEP Path to Final Prototype

*Philosophy: scale 6 GHz set-up to 1.3 GHz converting LNL QWR polishing system*

Priority: test RF performances after PEP

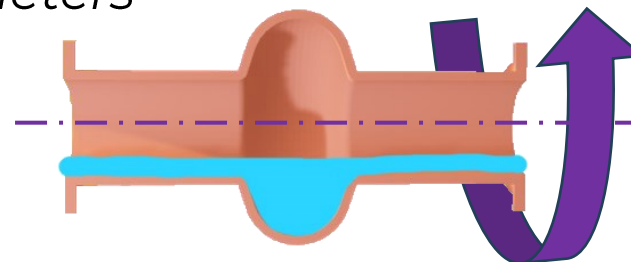
## 1. Simpler set-up: cavity fully immersed



1.3 GHz - 300 L

## 2. Alternative set-up to Reduce Process Power

- *Reduce Treated Area (rotating cavity)*
- *Optimizing Process Parameters (Temperature, Voltage, ...)*

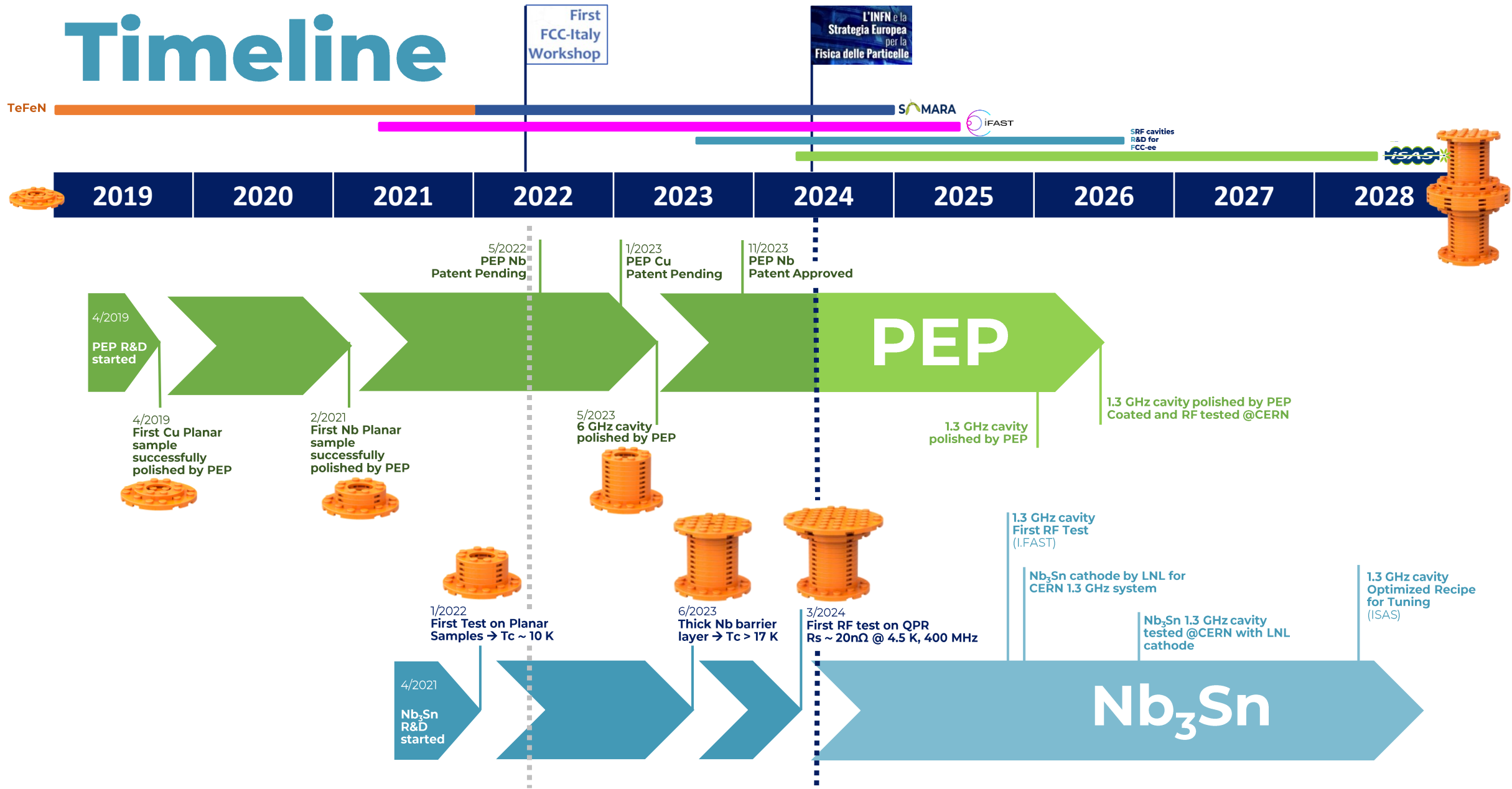


QWR Implant @LNL



# Timeline

TeV



# Conclusion

- ▶ **PEP and Nb<sub>3</sub>Sn films** are possible **game changer technologies** for SRF accelerating cavities
- ▶ **Big steps forward** in the last two years with transition from planar to 3D samples
- ▶ **Very promising results from first RF test**
- ▶ **Validation with 1.3 GHz cavities is necessary** prior to evaluating the feasibility of implementing these technologies in FCC-ee or FCC-HH
- ▶ **End of 2025** we expect to have the **first tests** available on **1.3 GHz cavities**
- ▶ **In 2028 optimized prototypes** are expected



Work supported by INFN CSN5 experiment SAMARA and INFN CSNI experiments SRF and RD\_FCC

This project has received funding from the European Union's Horizon-INFRA-2023-TECH-01 under GA No 101131435 – ISAS

and from the European Union's Horizon 2020 Research and Innovation programme under GA No 101004730 – IFAST



# Thank you!

Giovanni  
Marconato

Davide  
Ford

Eduard  
Chyhrynets

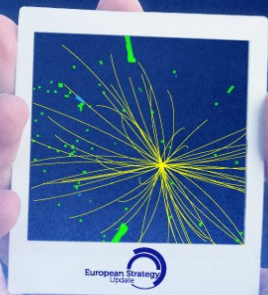
Cristian  
Pira

Dorothea  
Fonnesu

Roberta  
Caforio

Alessandro  
Salmaso

L'INFN e la  
Strategia Europea  
per la  
Fisica delle Particelle

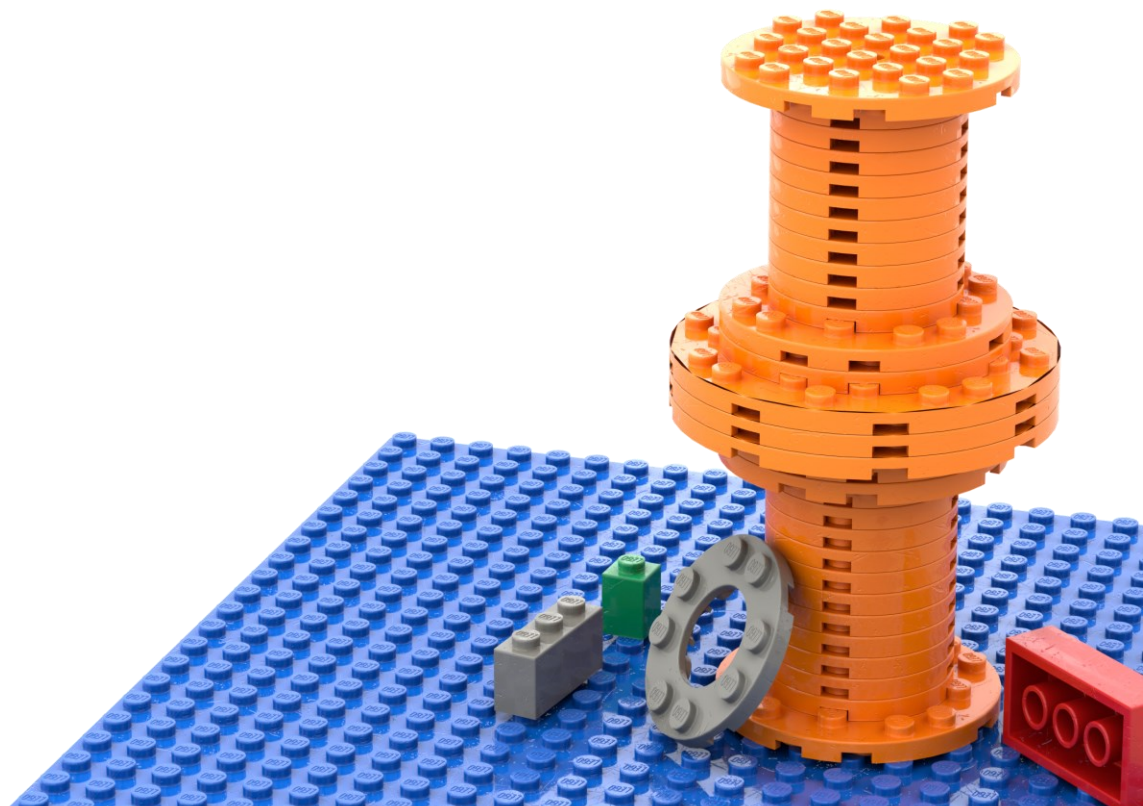


Roma 6-7 Maggio 2024  
Centro Congresso Frentani



Cristian Pira

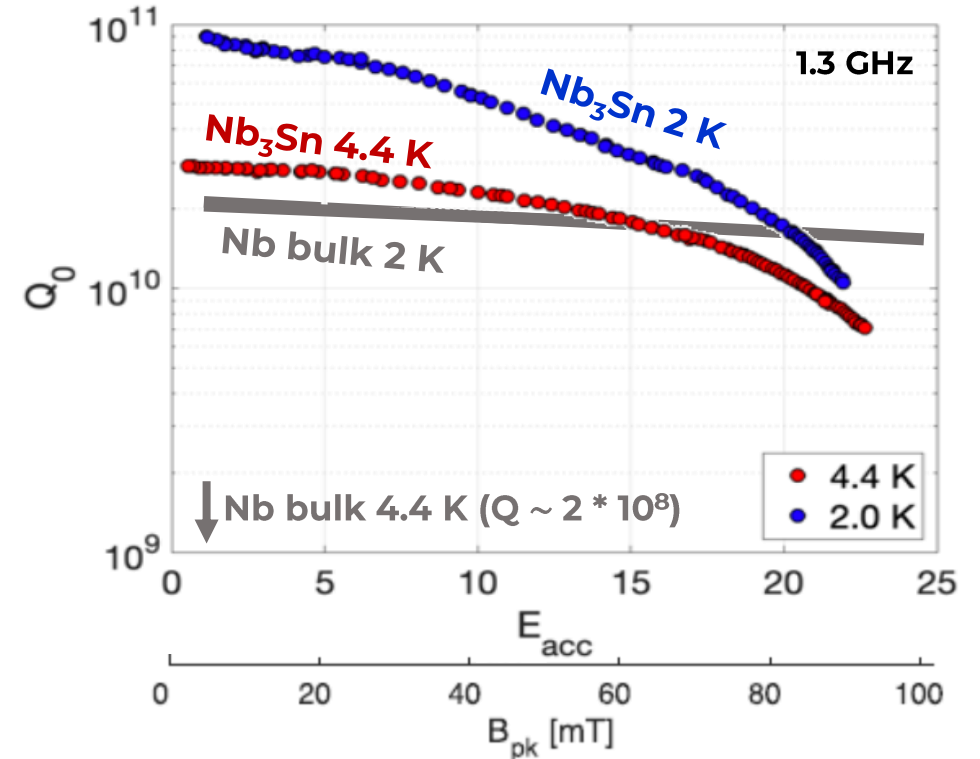
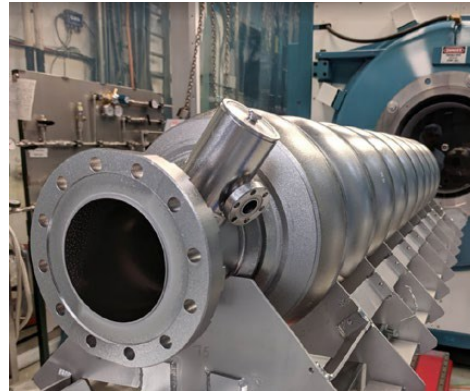
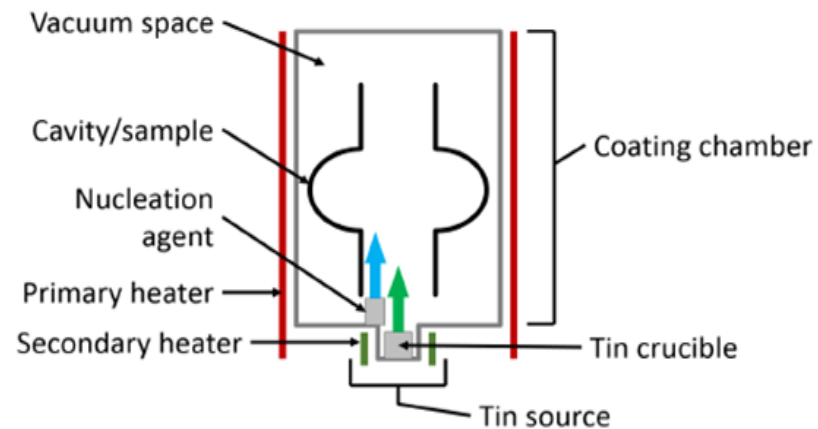
# Backup Slides



# Nb<sub>3</sub>Sn state of the art

## Vapor Tin Diffusion

Cornell, Fermilab, JLab, KEK

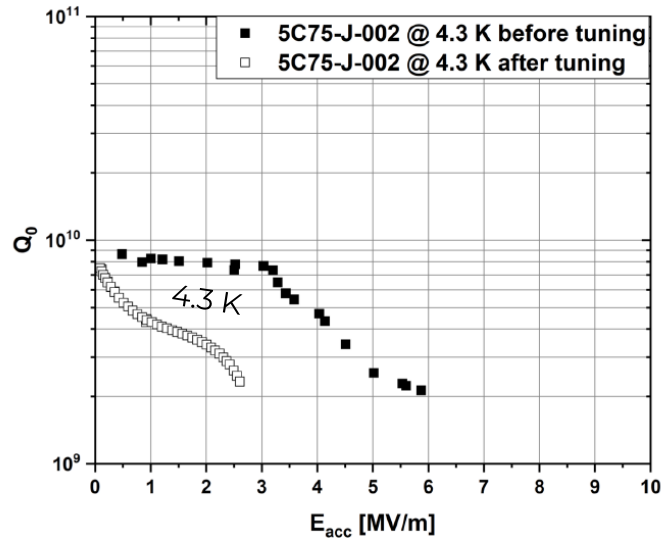


S. Posen, SRF 2019 proceedings (elaborated)

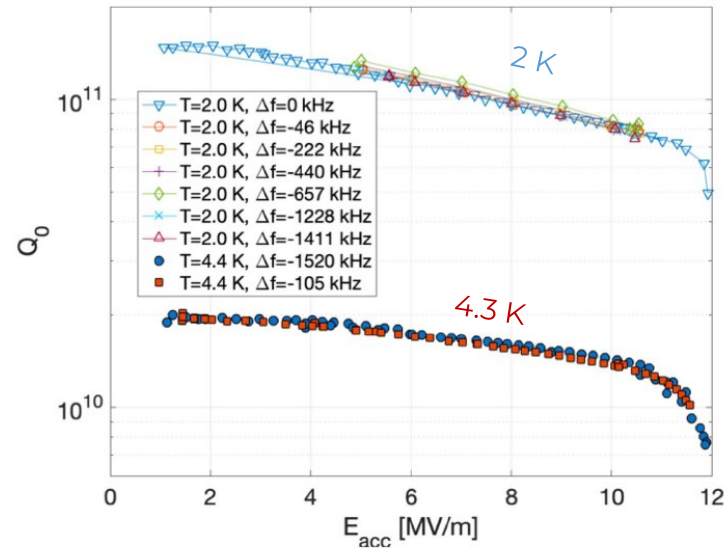
## Technology limitation:

- ▶ Reproducibility
- ▶ Substrate cost

# Cavity Tunability



**Strong performance degradation** after room temperature tuning for 200 kHz



**Little change** in the coated cavity performance after tuning up to 1400 kHz at cryogenic temperatures

## Nb<sub>3</sub>Sn is extremely brittle

*Eremeev, G. (2023). Tunability/robustness of Nb<sub>3</sub>Sn (No. FERMILAB-SLIDES-23-402-TD). Fermi National Accelerator Laboratory (FNAL), Batavia, IL (United States).*

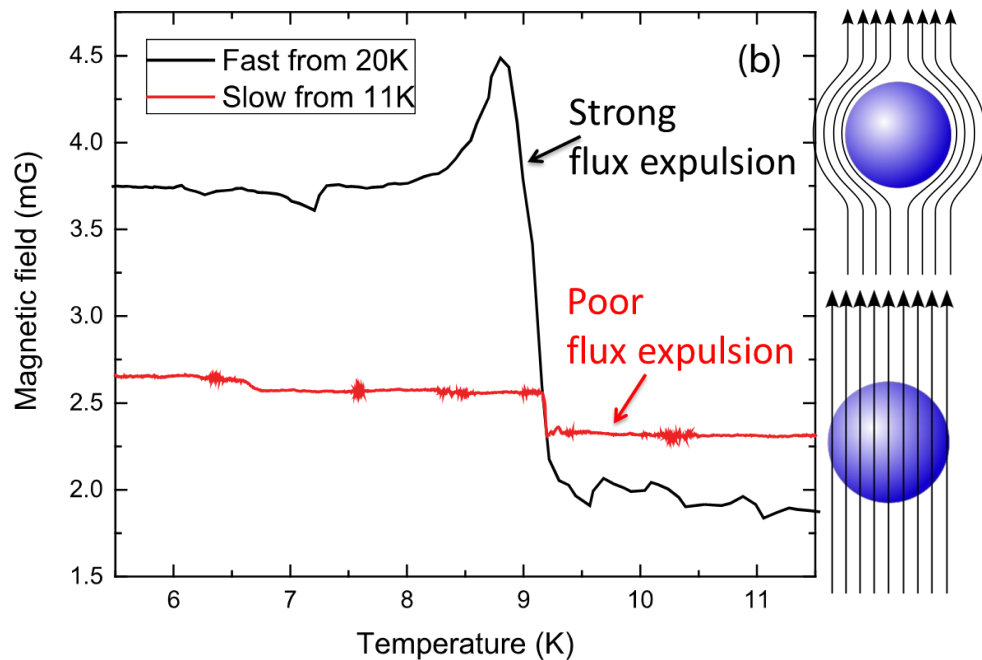
- ▶ Vapor Tin Diffusion Nb<sub>3</sub>Sn on Nb cavities can be tuned only at cryogenic T
- ▶ An interlayer in Nb<sub>3</sub>Sn on Cu coatings can be added to enhance film mechanical stability and tunability

# Trapped Flux

$$Q_0 \propto \frac{1}{R_{BCS} + R_{res} + \eta S B}$$

Fraction of Trapped Flux

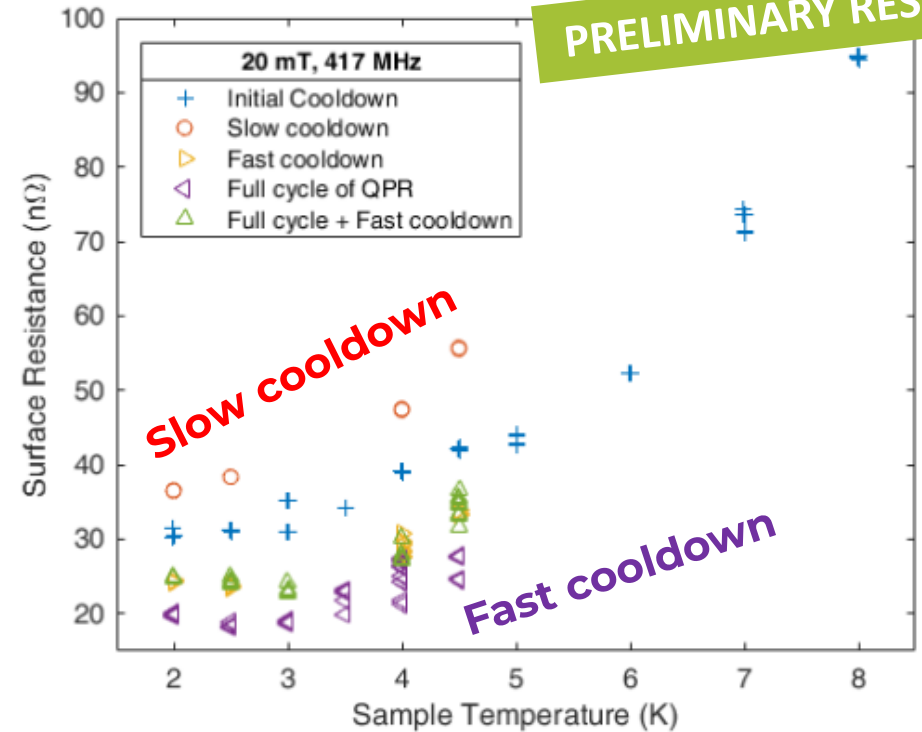
Sensitivity



A. Romanenko, A. Grassellino, O. Melnychuk, D. A. Sergatskov, *J. Appl. Phys.* 115, 184903 (2014)

## First ISAS Results:

PRELIMINARY RESULTS

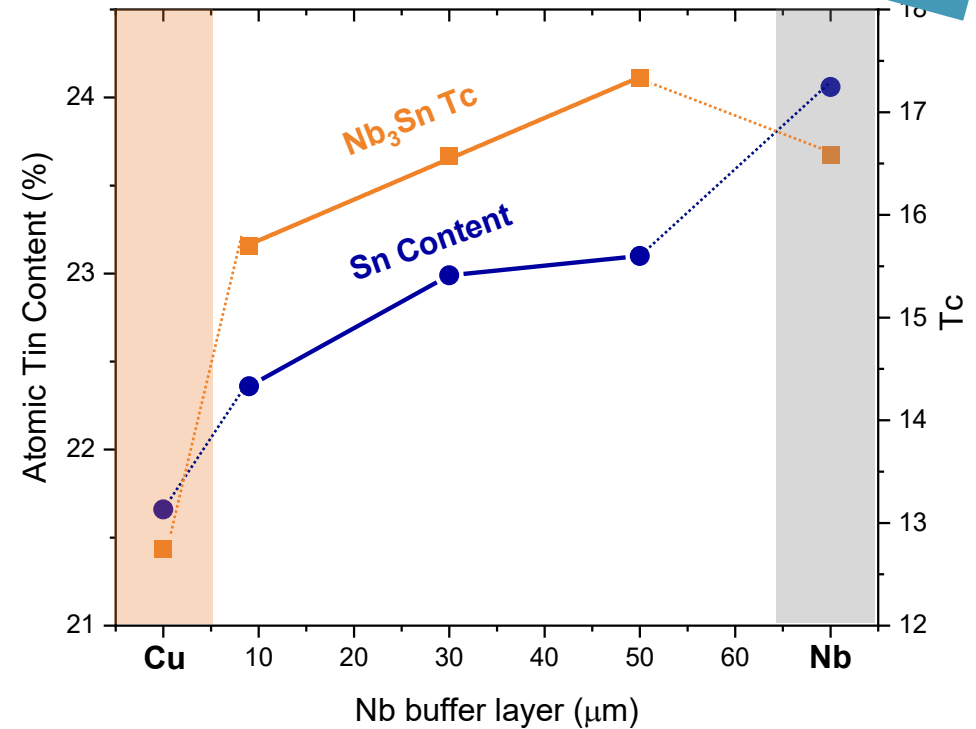
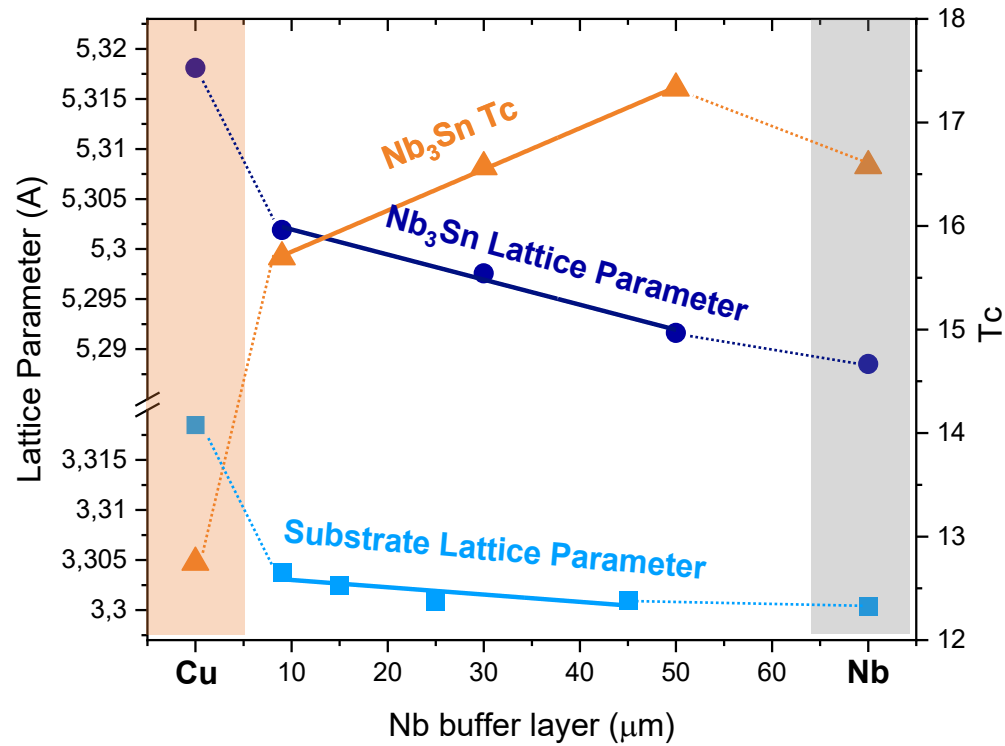


Courtesy of Oliver Kugeler and Sebastian Keckert

- ▶ Nb<sub>3</sub>Sn coating suffer flux trapping
- ▶ **Cooldown procedure influence Rs**

# Nb<sub>3</sub>Sn coatings

## Sputtering parameter optimization



The role of the thick Nb layer is to accommodate the Nb<sub>3</sub>Sn lattice parameter

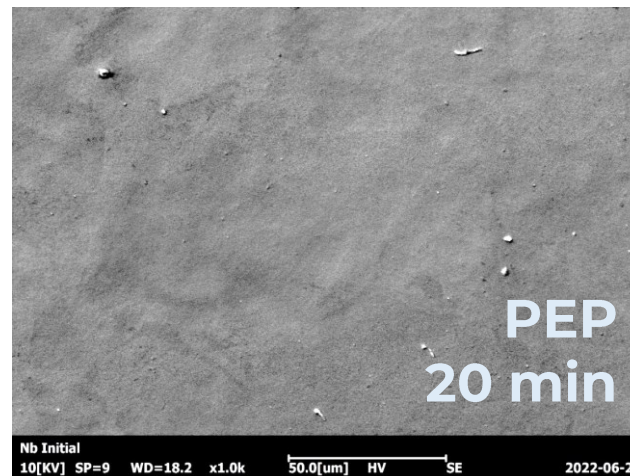
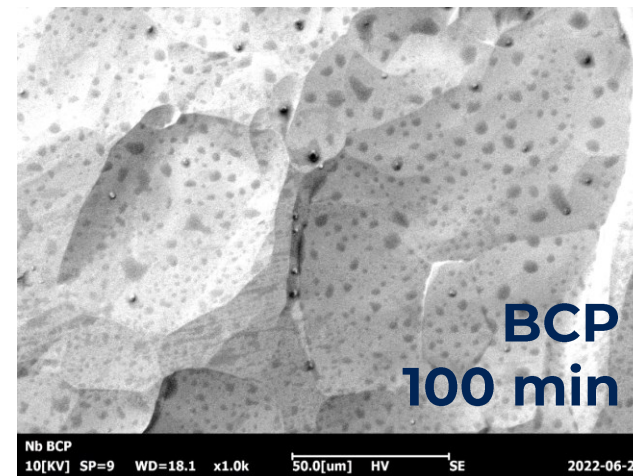
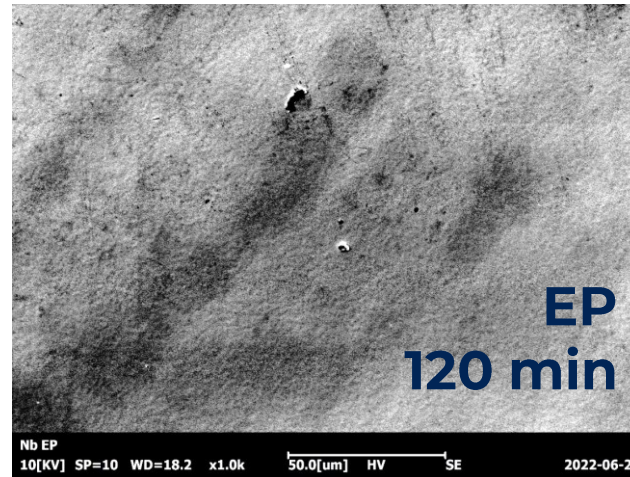
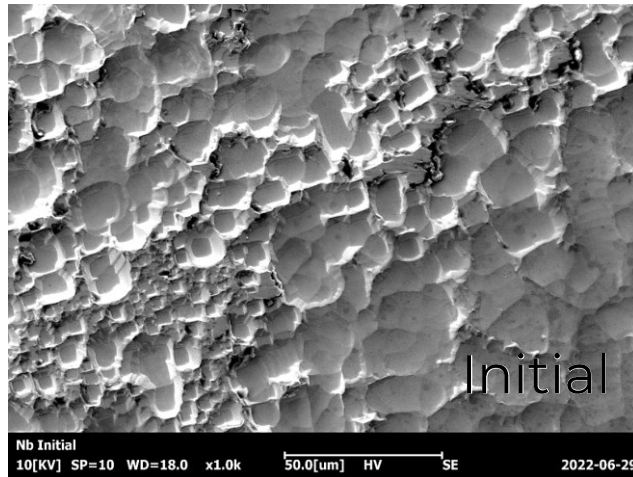
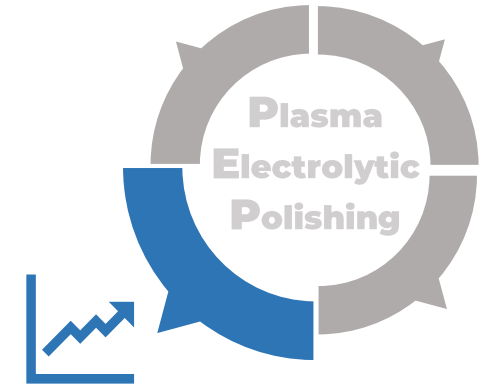


ALD layer could be an alternative to explore

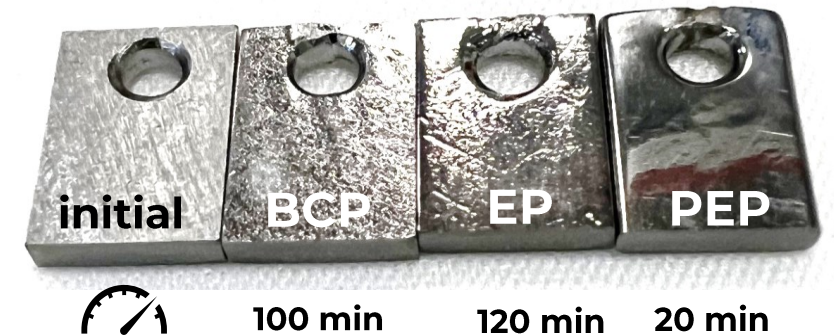


# PEP is Efficient

## Comparison with EP and BCP



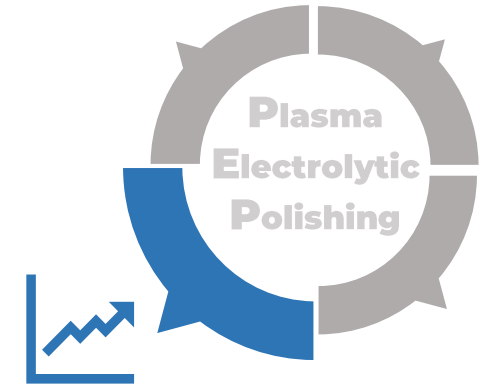
Nb, Magnification **1000x**;  
100  $\mu$ m Removal



Both micro and macro  
**roughness is improved significantly**

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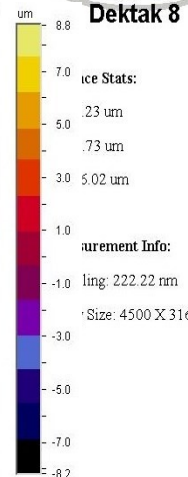
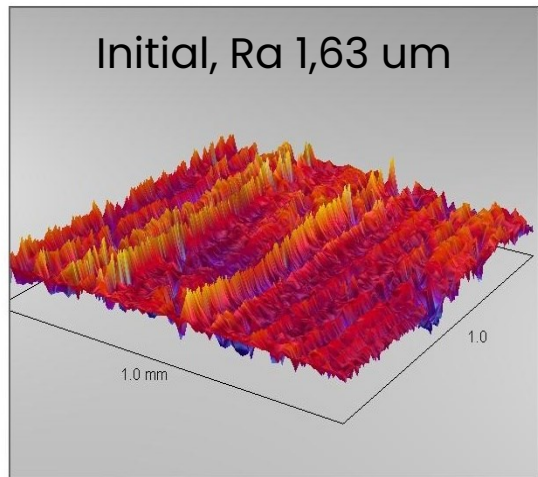
Dektak 8

Surface Stats:

Ra: 1.63  $\mu\text{m}$   
Rq: 2.11  $\mu\text{m}$   
Rt: 16.92  $\mu\text{m}$

Measurement Info:

Sampling: 222.22 nm  
Array Size: 4500 X 315



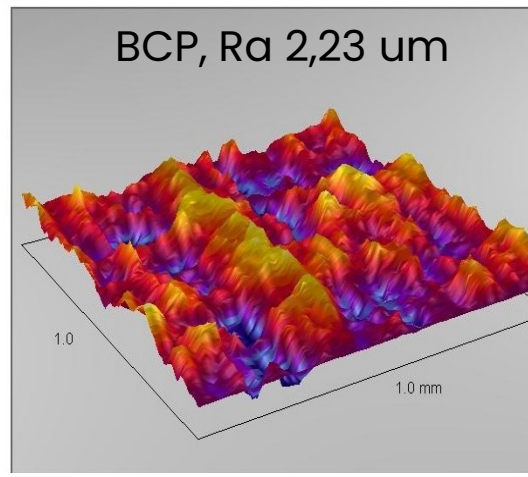
Dektak 8

Surface Stats:

Ra: 2.23  $\mu\text{m}$   
Rq: 2.73  $\mu\text{m}$   
Rt: 5.02  $\mu\text{m}$

Measurement Info:

Sampling: 222.22 nm  
Array Size: 4500 X 316



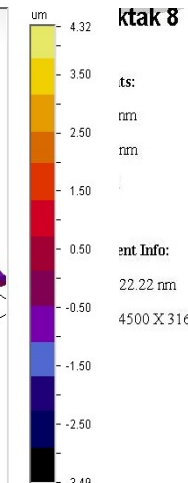
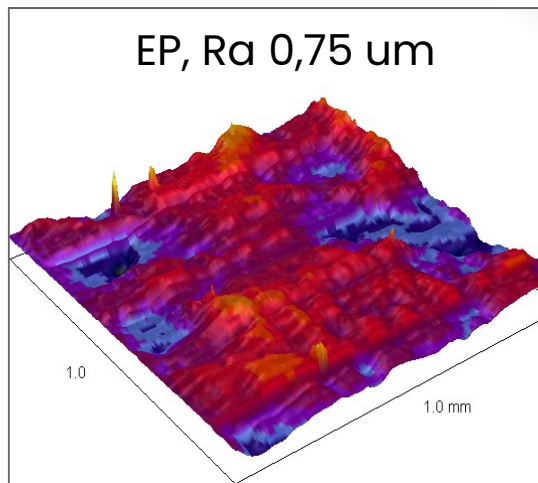
Dektak 8

Surface Stats:

Ra: 750.04 nm  
Rq: 927.93 nm  
Rt: 7.81  $\mu\text{m}$

Measurement Info:

Sampling: 333.33 nm  
Array Size: 3000 X 316



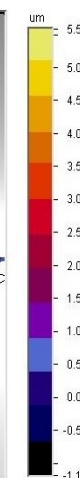
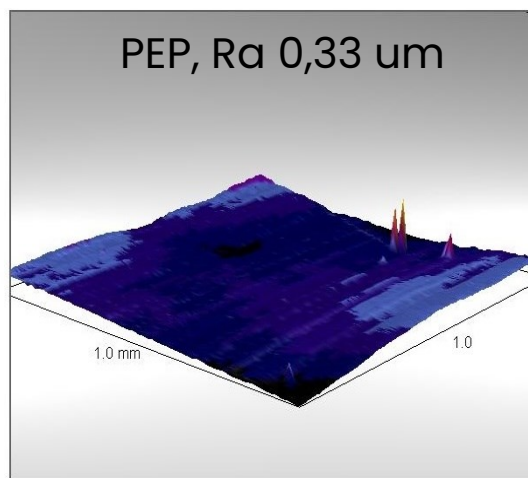
Dektak 8

Surface Stats:

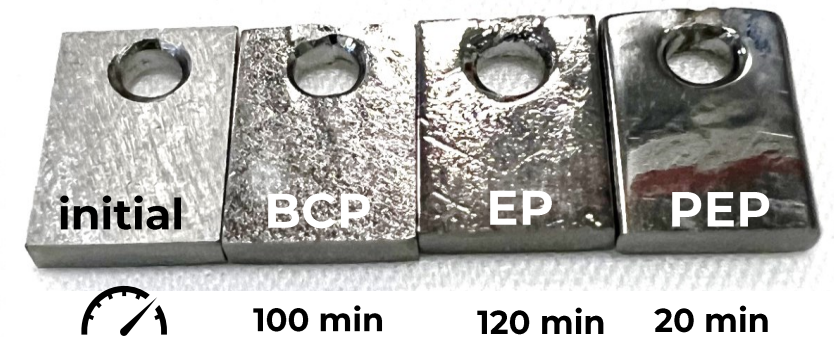
Ra: 0.33  $\mu\text{m}$   
Rq: 0.43  $\mu\text{m}$   
Rt: 0.50  $\mu\text{m}$

Measurement Info:

Sampling: 22.22 nm  
Array Size: 4500 X 316



Nb, Magnification **1000x**;  
100  $\mu\text{m}$  Removal



Both micro and macro  
**roughness is improved significantly**

# Comparison

## Copper treatments

Process / parameters	"SUBU5"	EP (3:2)	PEP in "SUBU5"
Solution composition	Sulfamic acid 5 g/l; NH <sub>4</sub> -citrate 1 g/l Butanol 50 ml/l; H <sub>2</sub> O <sub>2</sub> 50 ml/l	85 % H <sub>3</sub> PO <sub>4</sub> 60 p. 99% n-Butanol 40p.	Sulfamic acid 5 g/l; NH <sub>4</sub> -citrate 1 g/l Butanol 50 ml/l; H <sub>2</sub> O <sub>2</sub> 50 ml/l
Voltage	-	2-6 V	300 V
Current density	-	0,01 – 0,03 A/cm <sup>2</sup>	0,25-0,8 A/cm <sup>2</sup>
Power draw	-	0,06 – 0,18 W/cm <sup>2</sup>	75 – 240 W/cm <sup>2</sup>
Removing rate	1,5 μm/min (70±2 °C)	0,15-0,5 μm/min (25 °C)	20-30 μm/min (80 °C)